

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT4136135

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JAMES M. JOHNSON	11/08/2016
ALFRED L. CROUCH	11/08/2016
RECEIVING PARTY DATA	
Name:	SILICONAID SOLUTIONS, INC.
Street Address:	16000 ARBOR TRAIL
City:	BUDA
State/Country:	TEXAS
Postal Code:	78610
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15347753
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	512-657-4408
Email:	aap@penningtonipoffices.com
Correspondent Name:	PENNINGTON IP OFFICES, LLC
Address Line 1:	P.O. BOX 90053
Address Line 4:	AUSTIN, TEXAS 78709
NAME OF SUBMITTER:	ARTIE PENNINGTON
SIGNATURE:	/Artie Pennington/
DATE SIGNED:	11/09/2016
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 2	
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ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I,

James M. Johnson	Buda	Texas/USA
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have sold, assigned and transferred, and do hereby sell, assign and transfer unto SiliconAid Solutions, Inc., a corporation of the State of Texas, having its principal office at 16000 Arbor Trail, Buda, TX 78610, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in:

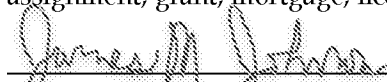
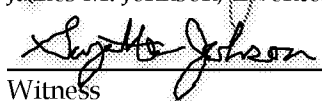
Using Embedded Time-Varying Code Generator to Provide Secure Access to Embedded Content in an On Chip Access Architecture

described, illustrated and claimed in an Application for Patent of the United States of America executed by me of even date herewith, together with the entire right, title and interest in and to said Application, and in and to Letters Patent which may be issued upon any Application for Letters Patent based on said Application, and upon any division, extension, continuation, or reissue of any such Application.

I hereby also sell, assign and transfer unto said SiliconAid Solutions, Inc., the entire right, title and interest in and to said invention, and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of said inventions and said applications for Letters Patent in foreign countries, and I further authorize said SiliconAid Solutions, Inc., to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of said application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby authorize and request the Commissioner for Patents of the United States of America to issue Letters Patent that may result from the timely filing of an Application for Letters Patent based on the aforesaid Application, as well as any division, extension, continuation or reissue of any such Application, to said SiliconAid Solutions, Inc., for the sole use and behoof of said SiliconAid Solutions, Inc., its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to said SiliconAid Solutions, Inc.

I agree that, when requested, I will, without charge to SiliconAid Solutions, Inc., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in said SiliconAid Solutions, Inc., its successors, assigns and legal representatives or nominees. I covenant with said SiliconAid Solutions, Inc., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.

	11/08/2016
James M. Johnson, inventor	Date
	11/08/2016
Witness	Date

ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I,

Alfred L. Crouch	Cedar Park	Texas/USA
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have sold, assigned and transferred, and do hereby sell, assign and transfer unto SiliconAid Solutions, Inc., a corporation of the State of Texas, having its principal office at 16000 Arbor Trail, Buda, TX 78610, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in:


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described, illustrated and claimed in an Application for Patent of the United States of America executed by me of even date herewith, together with the entire right, title and interest in and to said Application, and in and to Letters Patent which may be issued upon any Application for Letters Patent based on said Application, and upon any division, extension, continuation, or reissue of any such Application.

I hereby also sell, assign and transfer unto said SiliconAid Solutions, Inc., the entire right, title and interest in and to said invention, and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of said inventions and said applications for Letters Patent in foreign countries, and I further authorize said SiliconAid Solutions, Inc., to apply for Letters Patent in foreign countries directly in its own name, and to claim the priority of the filing date of said application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby authorize and request the Commissioner for Patents of the United States of America to issue Letters Patent that may result from the timely filing of an Application for Letters Patent based on the aforesaid Application, as well as any division, extension, continuation or reissue of any such Application, to said SiliconAid Solutions, Inc., for the sole use and behoof of said SiliconAid Solutions, Inc., its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to said SiliconAid Solutions, Inc.

I agree that, when requested, I will, without charge to SiliconAid Solutions, Inc., but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for said inventions in any and all countries and for vesting title thereto in said SiliconAid Solutions, Inc., its successors, assigns and legal representatives or nominees. I covenant with said SiliconAid Solutions, Inc., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.


Alfred L. Crouch Date

Witness Date